CLAIMS

[Claim 1]

An aggregate of flaked silver particles, the aggregate having a BET specific surface area of 0.5 m^2/g or more and less than 1.5 m^2/g and having, according to laser diffractometry, a 50% particle size of 1 to 4 μm and a 75% particle size/25% particle size ratio of 1.8 or less.

[Claim 2]

The aggregate of flaked silver particles according to Claim 1, wherein a reflectance of light having a wavelength of 400 to 800 nm is 40% or more.

[Claim 3]

A paste comprising the aggregate of flaked silver particles according to Claim 1 or 2.

[Claim 4]

The paste according to Claim 3, wherein the paste contains the aggregate of flaked silver particles in an amount of 50 to 90 wt%.

[Claim 5]

The paste according to any one of Claims 3 or 4, wherein the paste has a silver sedimentation ratio of 0.5% or less.

[Claim 6]

The paste according to any one of Claims 3 to 5, wherein the paste is an adhesive for fixing a light-emitting diode (LED) chip.